

Grade: PG-CN

Manufacturer: Minteq International Inc.

Method of Manufacturing: Hydrocarbon gas decomposition

Description: Pyrolytic Graphite (Continuously Nucleated) and has physical properties of about 15-20% higher than Substrate Nucleated (PG SN) grade of pyrolytic graphite. The material is manufactured by decomposition of a hydrocarbon gas at very high temperature in a vacuum furnace. The result is an ultra-pure product which is near theoretical density and extremely anisotropic. The material is deposited as graphene onto a substrate giving it a layered composition and is anisotropic. This also means it has different properties in one of the two dimensional planes. In the C plane (across its layers) it has low thermal conductivity, acting as an insulator. In the A-B plane (with the layers) it has very high thermal conductivity, acting as a superb conductor. All values are taken at room temperature, unless noted otherwise.

Physical Properties for Continuously Nucleated (CN) Pyrolytic Graphite

| Property | Direction* | Metric Units | English Units |
|-------------------------------|------------|--------------------------------|---------------------------------|
| Density | --- | 2.19 g/cc | 136 lb/ft3 |
| Flexural Strength | | | |
| Room Temperature | a | 840 kg/cm2 | 12,000 psi |
| 2750°C | a | 3,500 kg/cm2 | 50,000 psi |
| Compressive Strength | | | |
| Room Temperature | a | 1,200 kg/cm2 | 17,500 psi |
| | c | 3,565 kg/cm2 | 52,000 psi |
| Shear Strength | | | |
| Room Temperature | a | 1020 kg/cm2 | 14,500 psi |
| Coefficient Thermal Expansion | | | |
| Room Temperature | a | 0.066x10 ⁻⁶ cm/cm°C | 0.036x10 ⁻⁶ in/in°F |
| 2200°C | a | 1.49x10 ⁻⁶ cm/cm°C | 0.83x10 ⁻⁶ in/in°F |
| Room Temperature | c | 23.9x10 ⁻⁶ cm/cm°C | 13.28 x10 ⁻⁶ in/in°F |
| 2200°C | c | 25.0x10 ⁻⁶ cm/cm°C | 13.88x10 ⁻⁶ in/in°F |
| Thermal Conductivity | | | |
| Room Temperature | a | 440 W/m²K | 255 BTU/(hr ft2)(°F/ft) |
| 1650°C | a | 114 W/m²K | 66 BTU/(hr ft2)(°F/ft) |
| Room Temperature | c | 1.73 W/m²K | 1.00 BTU/(hr ft2)(°F/ft) |
| 3000°F | c | 1.30 W/m²K | 0.75 BTU/(hr ft2)(°F/ft) |
| Electric Resistivity | | | |
| Room Temperature | a | 500 μΩcm | |
| 1650°C | a | 200 μΩcm | |
| Room Temperature | c | 0.6 Ωcm | |
| 1650°C | c | 0.22 Ωcm | |
| Scleroscope Hardness | a | 101 | 101 |
| | c | 83 | 83 |
| Oxidation Threshold | | 650°C | 1200°F |
| Permeability | | Helium Leak Tight at 10-6 mmHg | |

*a: Along basal planes (across surface)
c: Through basal planes (through thickness)